ASSOCIATION CONNE	© Copyright 2005. IPG	Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both international and Pan-American copyright conventions.				This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with low level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.										
752-21.1		IPC Web Site for Information on IPC-1752 Standard http://www.ipc.org/IPC-175x Form Tyj Distributo														
upplier Info	ormation															
Company name*			Company unique ID			τ	Unique ID Authority					Response Date*				
nsemi													2024-05-15			
Contact Name			Title - Contac	Title - Contact			Phone - Contact*					Email - Contact*				
Product-Env-St	tewards		Product Enviro Compliance]	NA				Produ	Product-Env-Stewards@onsemi.com				
uthorized Rep	resentative*	Title - Representative			F	Phone - Representative*				Email -	Email - Representative*					
Product-Env-St	tewards	Product Enviro Compliance			1	NA				Produ	Product-Env-Stewards@onsemi.com					
Requ	uester Item Number	Mfr Iten	tem Number Mfr Item Name				Effective Date	Version Manufacturing Sit		ite	Weight*		UOM	Unit Type		
		NLVLV		X4245DTR2G LOG 8BIT DUAL SUPPL			2024-05-15 PH1		H1		69.68	69.68 mg		Each		
Ianufacturi	ng Proccess Informati	on														
Termi	Terminal Plating / Grid Array Material		Terminal Base Alloy J		J-STD-020 MS	ΓD-020 MSL Rating		Peak Process Body Temperatur		re Max Time at Peak Temper		ature	Number	of Reflow Cyc	cles	
Precious metal (e.g. Ag,Au, NiPdAu) (no Sn)		Au) (no	CU Alloy 1		1		260		C 30		seco	nds	3			
Comments								-								
vel 1 - maximu	ım time at peak temperatur	e during so	ldering is 10-3	0 seconds												
	nation regarding material co															

RoHS Material Composition Declaration			Declaration Type *	Detail	led						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).											
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information is trought in this form using appropriate methods to ensure its accuracy and that such information is true and correct to the best of its knowledge and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on informationprovided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier have provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier enter into a written agreement with respect to the identified part, the terms and conditions of that agreement, including any warranty rights and/or remedies of Supplier's Standard Terms and Conditions of Sale applicable to such part shall apply.											
RoHS Declaration * 1 - Item	(s) does not contain RoHS restricted substa	ances per the definition above	Supplier Ac	ceptance *	Accepted						
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.											
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
Instructional Complete all of the required	fields on all neggs of this form. Calcut th		a duan dawn. This will display the signature on	a Digitally sign	the declaration (if recruired by the						
Instructions: Complete all of the required Requester) and click on Submit Form to			e drop-down. This will display the signature ar	ea. Digitally sign	the declaration (if required by the						

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	3.12	mg	Supplier	Silicon (Si)	7440-21-3		3.12	mg
Die Attach	1.26	mg	Supplier	Silver (Ag)	7440-22-4		0.945	mg
			Supplier	Epoxy resins	129915-35-1		0.315	mg
Lead Frame	16.21	mg	Supplier	Iron (Fe)	7439-89-6		0.308	mg
			Supplier	Copper (Cu)	7440-50-8		15.902	mg
Mold Compound-Black	45.76	mg		Epoxy Phenol Resin	proprietary data		4.8048	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		40.9552	mg
Plating	2.91	mg	Supplier	Palladium (Pd)	7440-05-3		0.2212	mg
			В	Nickel (Ni)	7440-02-0		2.6481	mg
			Supplier	Gold (Au)	7440-57-5		0.0407	mg
Wire Bond - Au	0.42	mg	Supplier	Gold (Au)	7440-57-5		0.42	mg